



## P-Channel MOSFET MEM2303M3

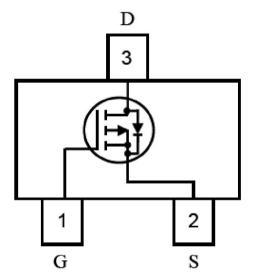
#### **General Description**

MEM2303M3G Series P-channel enhancement mode field-effect transistor ,produced with high cell density DMOS trench technology, which is especially used to minimize on-state resistance. This device particularly suits low voltage applications, and low power dissipation,and low power dissipation in a very small outline surface mount package.

#### Features

- -30V/-4.2A
  R<sub>DS(ON)</sub>=55mΩ@ V<sub>GS</sub>=-10V,I<sub>D</sub>=-4.2A
  R<sub>DS(ON)</sub>=62mΩ@ V<sub>GS</sub>=-4.5V,I<sub>D</sub>=-4A
  R<sub>DS(ON)</sub>=72mΩ@ V<sub>GS</sub>=-2.5V,I<sub>D</sub>=-2.5A
- High Density Cell Design For Ultra Low On-Resistance
- Subminiature surface mount package:SOT23-3L

### Pin Configuration



#### **Typical Application**

- Power management
- Load switch
- Battery protection

#### **Absolute Maximum Ratings**

Parameter		Symbol	Symbol Ratings	
Drain-Source Voltage		V <sub>DSS</sub>	-30V	V
Gate-Source Voltage		V <sub>GSS</sub>	±12	V
Drain	T <sub>A</sub> =25℃		-4.2	Α
Current	T <sub>A</sub> =70℃	- I <sub>D</sub> -	-3.5	
Pulsed Drain Current <sup>1,2</sup>		I <sub>DM</sub>	-30	A
Total Power	T <sub>A</sub> =25℃	Pd -	1.4	W
Dissipation	T <sub>A</sub> =70℃		1	vv
Operating Temperature Range		T <sub>Opr</sub>	150	°
Storage Temperature Range		T <sub>stg</sub>	-65/150	



#### **Thermal Characteristics**

Parameter		Symbol	TYP.	MAX.	Unit
Thermal Resistance,	t≤10s	RθJA	65	90	°C <b>/W</b>
Junction-to-Ambient	12105	ROJA	05	90	CIVV
Thermal Resistance,	Steady-State	RθJA	85	125	°C <b>/W</b>
Junction-to-Ambient	Sleauy-Slale		00		
Thermal Resistance,	Stoody State	RθJL	42	60	°C/W
Junction-to-Lead	Steady-State	KOJL	43	00	C/ <b>VV</b>

#### **Electrical Characteristics**

#### MEM2303M3G

Parameter	Symbol	Test Condition	Min	Туре	Max	Unit
	S	tatic Characteristics				
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA	-30	-35		V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}$ = $V_{GS}$ , $I_D$ =-250uA	-0.7	-1.0	-1.3	V
Gate-Body Leakage	1	$V_{DS}$ =0V, $V_{GS}$ =12V		3	100	nA
Gale-Dody Leakage	I <sub>GSS</sub>	$V_{DS}$ =0V, $V_{GS}$ =-12V		-3	-100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =-24V $V_{GS}$ =0V		-3.5	-1000	nA
	R <sub>DS(ON)1</sub>	$V_{GS}$ =-10V,I <sub>D</sub> =-4.2A		55	58	mΩ
Static Drain-Source On-Resistance	R <sub>DS(ON)2</sub>	$V_{GS}$ =-4.5V,I <sub>D</sub> =-4A		62	65	mΩ
	R <sub>DS(ON)3</sub>	V <sub>GS</sub> =-2.5V,I <sub>D</sub> =-2.5A		72	90	mΩ
Forward Transconductance	<b>g</b> fs	$V_{DS}$ = -5 V, I <sub>D</sub> = -2.8 A	7	11		S
Maximum Body-Diode Continuous Current	ls				-2.2	А
Source-drain(diode forward) voltage	$V_{\text{SD}}$	V <sub>GS</sub> =0V,I <sub>D</sub> =-1A		-0.8	-1.0	V
	Dy	namic Characteristics				
Input Capacitance	Ciss	VGS=0V, VDS=-15V,		954		pF
Output Capacitance	Coss	f=1MHz		115		
Reverse Transfer Capacitance	Crss	I- IIVII 12		77		
Gate resistance	Rg	VGS=0V, VDS=0V, f=1MHz		6		Ω
	Swi	itching Characteristics				
Turn-On Delay Time	td(on)			6.5		
Rise Time	tr	VGS=-10V,VDS=-15V,		3.5		ns
Turn-Off Delay Time	td(off)	td(off) RL=3.6Ω,RGEN=6Ω		38		
Fall-Time	tf			12		
Total Gate Charge	Qg	V <sub>DS</sub> = -15 V,		9.5		
Gate-Source Charge	Qgs	V <sub>GS</sub> = -4.5 V,		2		nc
Gate-Drain Charge	Qgd	I <sub>D</sub> = -4A		3		

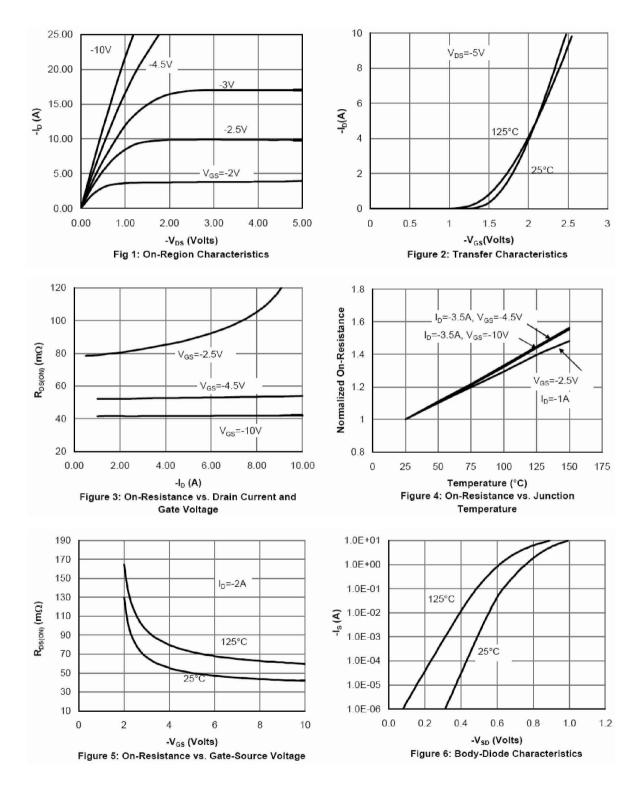
1. Pulse width limited by Max. junction temperature.



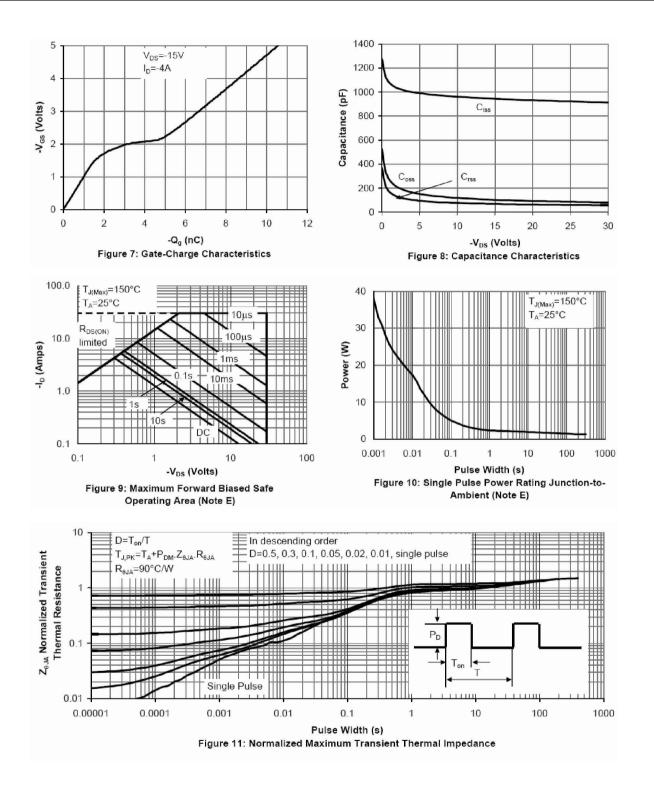
MEM2303

2、Pulse width <300us, duty cycle <0.5%.

#### **Typical Performance Characteristics**

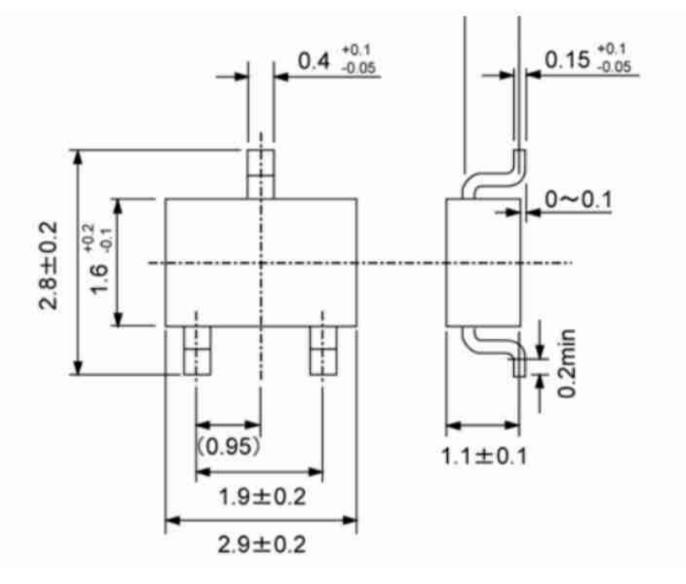








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